

## Low-Drift, Low-Power, Small-Footprint Series Voltage Reference

### 1 Features

- Initial accuracy:  $\pm 0.08\%$  (maximum)
- Temperature coefficient: 3 ppm/ $^{\circ}\text{C}$
- Operating temperature range:  $-40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$
- Output current:  $\pm 10\text{ mA}$
- Low quiescent current: 125  $\mu\text{A}$
- Ultra-low zero load dropout voltage: 200 mV
- Input voltage: 2.7 ~ 5.5 V
- Output 1/f noise (0.1 Hz to 10 Hz): 15  $\mu\text{Vp-p/V}$
- Long-term stability: 45 ppm/1000 hrs
- Small footprint 6 pin SOT-23 package pinouts:

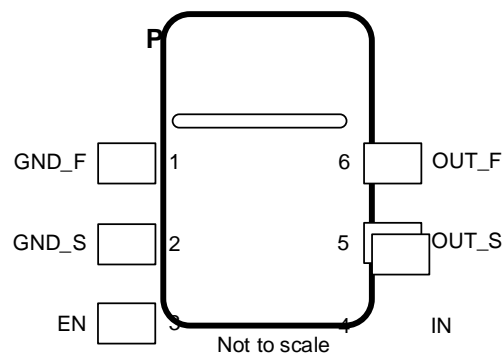
### 2 Applications

- Data acquisition systems
- Analog I/O modules
- Field transmitters
- Lab & field instrumentation
- Servo drive control modules
- DC power supply, AC source, electronic load

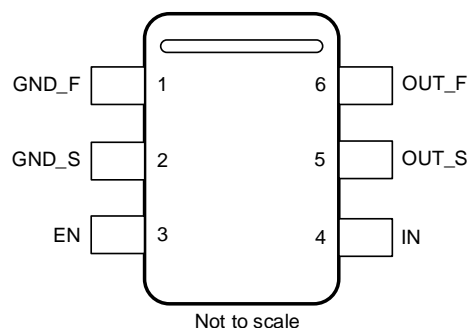
#### Device Information

PART NAME	PACKAGE (PIN) <sup>(1)</sup>	BODY SIZE (NOM)
CI3433	SOT-23 (6)	2.92 mm x 1.62 mm

(1) For all available packages, see the orderable addendum at the end of the data sheet



## 5 Pin Configuration and Functions



**Figure 1. CI3433  
6-Pin SOT-23  
Top View**

**Table 1. Pin Functions**

PIN		TYPE	DESCRIPTION
NAME	PIN		
GND_F	1	Ground	Ground force connection.
GND_S	2	Ground	Ground sense connection.
EN	3	Input	Enable connection. Enables or disables the device.
IN	4	Power	Input supply voltage connection.
OUT_S	5	Input	Reference voltage output sense connection.
OUT_F	6	Output	Reference voltage output force connection.

## 6 Specifications

### 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted) <sup>(1)</sup>

		MIN	MAX	UNIT
Input voltage	IN	-0.3	5.5	V
	EN	-0.3	IN	V
Output voltage	V <sub>OUT</sub>	-0.3	5.5	V
Output short circuit current	I <sub>SC</sub>		30	mA
Operating temperature range	T <sub>A</sub>	-55	150	°C
Storage temperature range	T <sub>stg</sub>	-60	150	°C

(1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied. These are stress ratings only and functional operation of the device at these or any other conditions beyond those specified in the Electrical Characteristics Table is not implied.

### 6.2 ESD Ratings

			VALUE	UNIT
V <sub>(ESD)</sub>	Electrostatic discharge	Human-body model (HBM), per ANSI/ESDA/ JEDEC JS-001 <sup>(1)</sup>	±2000	V
		Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup>	±1000	V

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 6.3 Recommended Operating Conditions

over operating ambient temperature range (unless otherwise noted)

		MIN	NOM	MAX	UNIT
IN	Input voltage	$V_{OUT} + V_{DO}^{(1)}$		5.5	V
EN	Enable voltage	0		IN	V
$I_L$	Output current	-10		10	mA
$T_A$	Operating Temperature	-40	25	125	°C

(1)  $V_{DO}$  = Dropout voltage

### 6.4 Thermal Information

THERMAL METRIC		SOT23-6	UNIT
$R_{\theta JA}$	Junction-to-ambient thermal resistance	131	°C/W
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	83	°C/W

### 6.5 Electrical Characteristics

At  $V_{IN} = V_{OUT} + V_{DO}$ ,  $C_L = 1 \mu F$ ,  $C_{IN} = 0.1 \mu F$ ,  $I_L = 0$  mA, minimum and maximum specifications at  $T_A = -40^\circ C$  to  $125^\circ C$ ;

Typical specifications at  $T_A = 25^\circ C$  (Unless otherwise noted).

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
ACCURACY AND DRIFT							
	Output voltage	T <sub>A</sub> = 25°C		3.30			V
	Output voltage accuracy	T <sub>A</sub> = 25°C		-0.08		+0.08	%
	Output voltage temperature coefficient <sup>(1)</sup>	-40°C ≤ T <sub>A</sub> ≤ 125°C			3	8	ppm/°C
LINE & LOAD REGULATION							
ΔV <sub>O</sub> /ΔV <sub>IN</sub>	Line Regulation	V <sub>IN</sub> = V <sub>OUT</sub> + V <sub>DO</sub> <sup>(2)</sup> to 5.5 V		15			ppm/V
ΔV <sub>O</sub> /ΔI <sub>L</sub>	Load Regulation	I <sub>L</sub> = 0 mA to 10mA, V <sub>IN</sub> = V <sub>OUT</sub> + V <sub>DO</sub> <sup>(3)</sup>	T <sub>A</sub> = 25°C, Sourcing	5			ppm/mA
		I <sub>L</sub> = 0 mA - 10mA, V <sub>IN</sub> = V <sub>OUT</sub> + V <sub>DO</sub>	T <sub>A</sub> = 25°C, Sinking	20			
I <sub>SC</sub>	Short circuit current	V <sub>OUT</sub> = 0 V at T <sub>A</sub> = 25°C		30			mA
NOISE							
e <sub>np-p</sub>	Low frequency noise	0.1Hz ≤ f ≤ 10Hz		15			μV <sub>P-P</sub> /V
e <sub>n</sub>	Integrated wide band noise	10Hz ≤ f ≤ 10kHz		40			μV <sub>rms</sub>
LONG TERM STABILITY AND HYSTERESIS							
	Long-term stability	SOT23-6 Package	0 to 1000h at 25°C	45			ppm
	Output voltage thermal hysteresis	SOT23-6 Package	25°C, -40°C, 125°C, 25°C Cycle 1	120			ppm
			25°C, -40°C, 125°C, 25°C Cycle 2	60			
TURN-ON TIME							
t <sub>ON</sub>	Turn-on time	0.1% of output voltage settling, C <sub>L</sub> = 10 μF		5			ms
CAPACITIVE LOAD							

C <sub>L</sub>	Stable output capacitor range	−40°C ≤ TA ≤ 125°C	0.1	10	μF
POWER SUPPLY					
V <sub>IN</sub>	Input voltage		V <sub>OUT</sub> + V <sub>DO</sub>	5.5	V
I <sub>L</sub>	Output current capacity	V <sub>IN</sub> = V <sub>OUT</sub> + V <sub>DO</sub> to 5.5 V	-10	10	mA
I <sub>Q</sub>	Quiescent current	Active mode	125		μA
		Shutdown mode	4		
V <sub>EN</sub>	ENABLE pin voltage	Voltage reference in active mode (EN = 1)	0.6 × I <sub>N</sub>		V
		Voltage reference in shutdown mode (EN = 0)	0.5		
V <sub>DO</sub>	Dropout voltage	I <sub>L</sub> = 0 mA	160		mV
		I <sub>L</sub> = 10 mA	250		
I <sub>EN</sub>	ENABLE pin leakage current	V <sub>EN</sub> = V <sub>IN</sub> = 5.5V	0.1		μA

(1) Temperature drift is specified according to the box method.

(2)  $V_{DO}$  for line regulation test is 300 mV.

(3)  $V_{DO}$  for load regulation test is 500 mV.

## 6.6 Typical Characteristics

At  $T_A = 25^\circ\text{C}$ ,  $V_{IN} = V_{EN} = 5.0\text{V}$ ,  $I_L = 0\text{mA}$ ,  $C_L = 1\mu\text{F}$ ,  $C_{IN} = 0.1\mu\text{F}$  (unless otherwise noted).

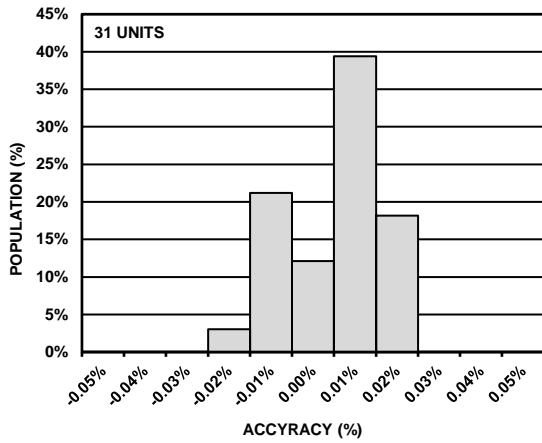


Figure 2: Initial Accuracy

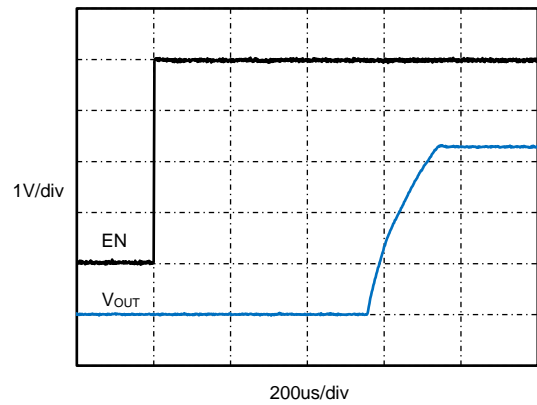


Figure 3: Turnon Time(Enable)

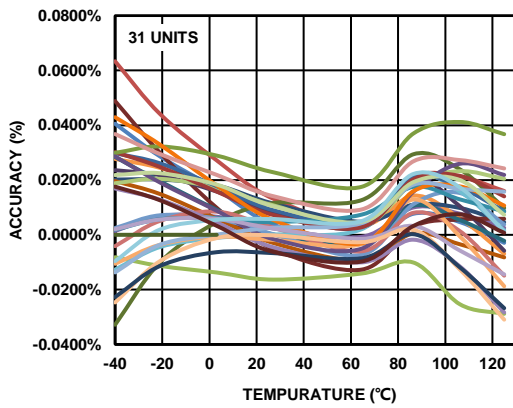


Figure 4: Output Voltage Accuracy vs. Temperature

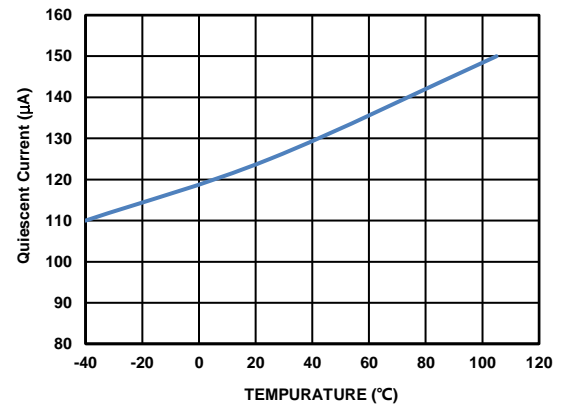


Figure 5: Quiescent Current vs. Temperature

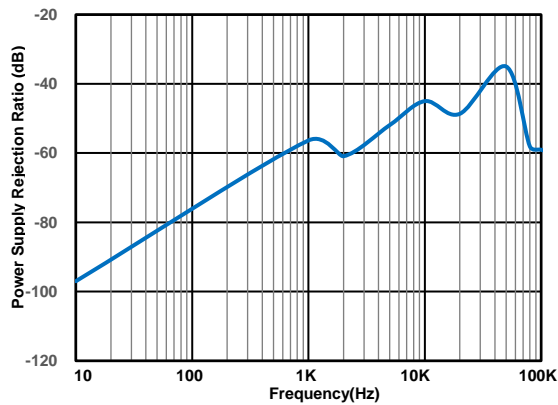


Figure 6: Power-Supply Rejection Ratio vs. Frequency

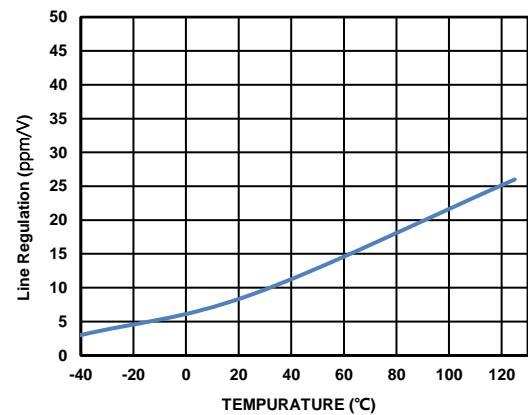


Figure 7: Line Regulation vs. Temperature

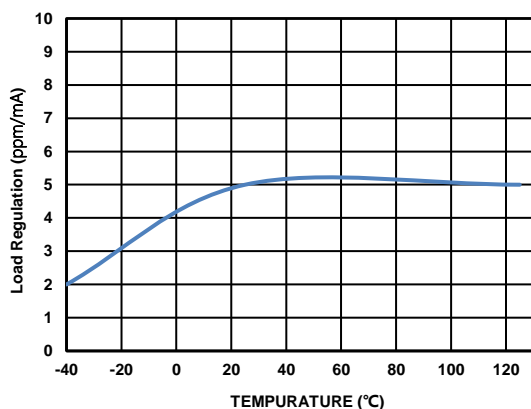


Figure 8: Load Regulation Sourcing

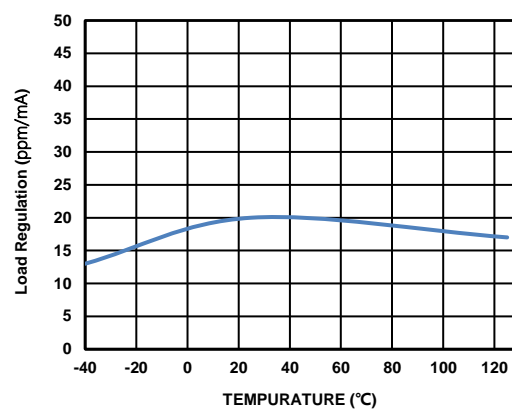


Figure 9: Load Regulation Sinking

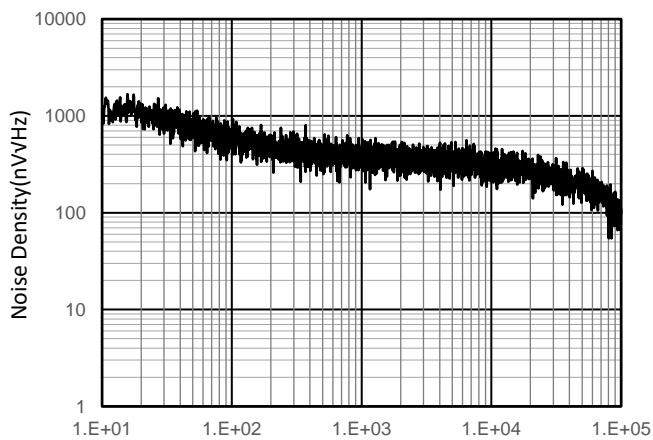


Figure 10: Noise Performance 1Hz to 100kHz

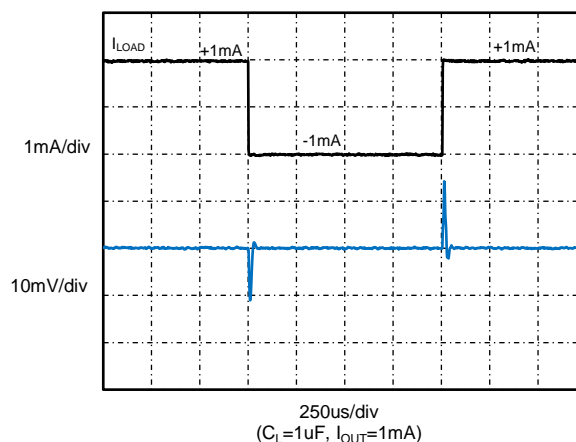


Figure 11: Load Transient

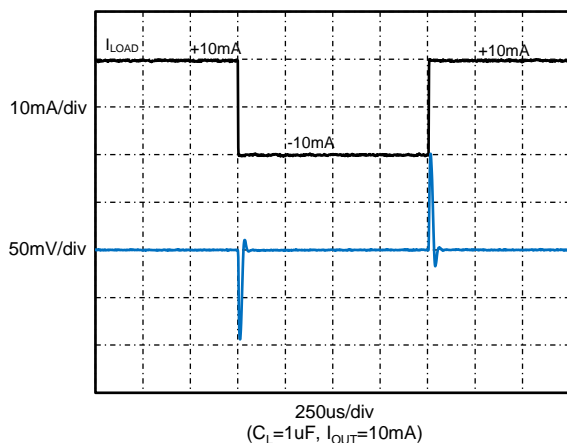


Figure 12: Load Transient

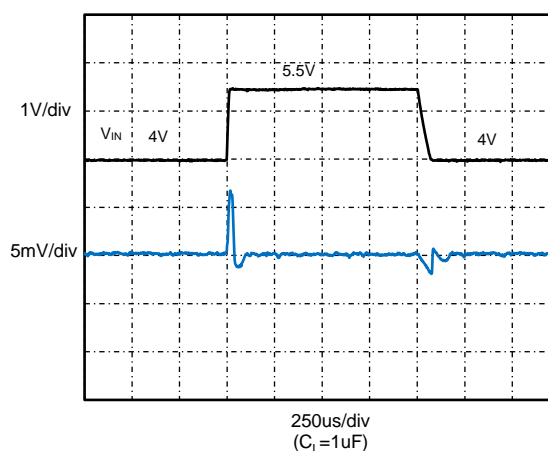
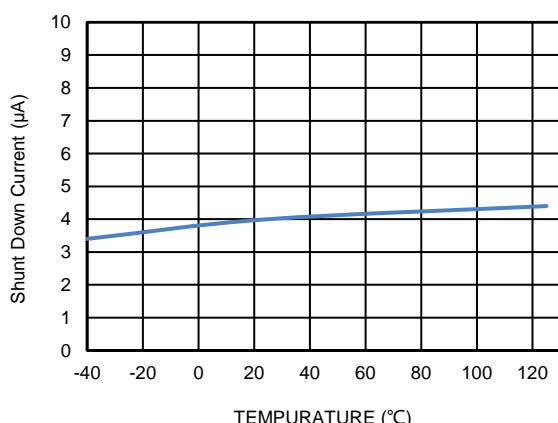
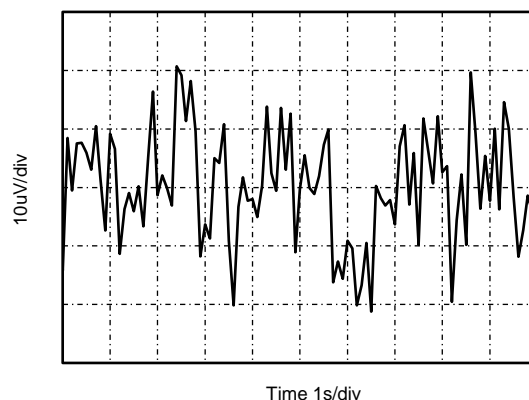


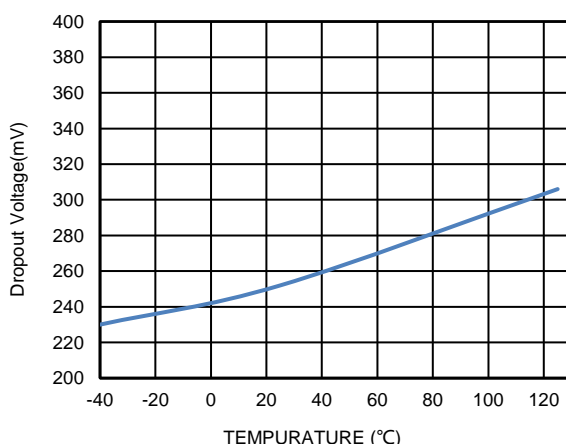
Figure 13: Line Transient



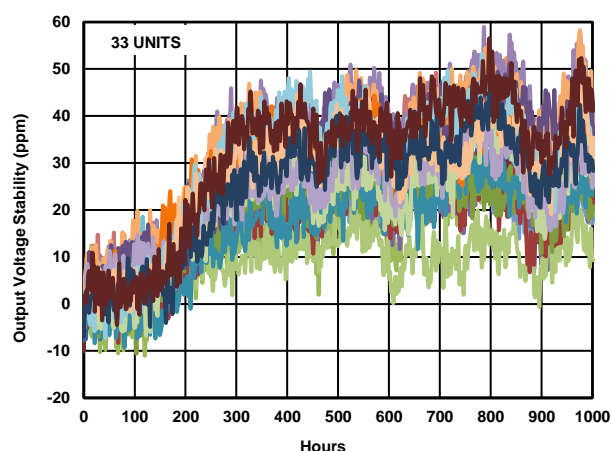
**Figure 14: Shunt Down Current vs. Temperature**



**Figure 15: 0.1-Hz to 10-Hz Noise(V<sub>OUT</sub>=3.3V)**



**Figure 16: Dropout Voltage(I<sub>OUT</sub>=10mA)**



## 7 Parameter Measurement Information

### 7.1 Long-Term Stability

One of the key parameters of the ADR3430 references is long-term stability. Typical characteristic expressed as: Figure 17 show the typical drift value for the ADR3430 is 45 ppm from 0 to 1000 hours. This parameter is characterized by measuring 33 units at regular intervals for a period of 1000 hours. It is important to understand that long-term stability is not ensured by design and that the output from the device may shift beyond the typical 30 ppm specification at any time. For systems that require highly stable output voltages over long periods of time, the designer should consider burning in the devices prior to use to minimize the amount of output drift exhibited by the reference over time.

### 7.2 Power Dissipation

The ADR3430 voltage references are capable of source and sink up to 10 mA of load current across the rated input voltage range. However, when used in applications subject to high ambient temperatures, the input voltage and load current must be carefully monitored to ensure that the device does not exceed its maximum power dissipation rating. The maximum power dissipation of the device can be calculated with Equation 1:

$$T_J = T_A + P_D \times R_{\theta JA} \quad (1)$$

where

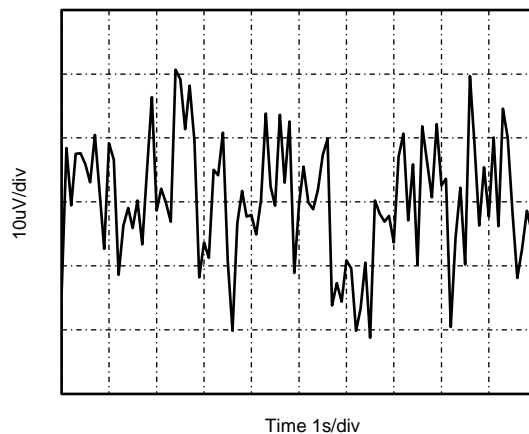
- $P_D$  is the device power dissipation

- $T_J$  is the device junction temperature
- $T_A$  is the ambient temperature
- $R_{\theta JA}$  is the package (junction-to-air) thermal resistance

Because of this relationship, acceptable load current in high temperature conditions may be less than the maximum current-sourcing capability of the device. In no case should the device be operated outside of its maximum power rating because doing so can result in premature failure or permanent damage to the device.

### 7.3 Noise Performance

Typical 0.1-Hz to 10-Hz voltage noise can be seen in Figure 18 . Device noise increases with output voltage and operating temperature. Additional filtering can be used to improve output noise levels, although care must be taken to ensure the output impedance does not degrade ac performance. Peak-to-peak noise measurement setup is shown in Figure 18.



**Figure 18: 0.1-Hz to 10-Hz Noise(V<sub>OUT</sub>=3.3V)**



## 8.4 Device Functional Modes

### 8.4.1 EN Pin

When the EN pin of the CI3433 is pulled high, the device is in active mode. The device must be in active mode for normal operation. The CI3433 can be placed in a low-power mode by pulling the enable pin low. When in shutdown mode, the output of the device becomes high impedance and the quiescent current of the device reduces to 4  $\mu$ A in shutdown mode. The EN pin must not be pulled higher than VIN supply voltage. See the Section 6.5 for logic high and logic low voltage levels.

### 8.4.2 Negative Reference Voltage

For applications requiring a negative and positive reference voltage, the CI3433 can be used to provide a dual-supply reference from a 5V supply. Figure 20: CI3433 Create Positive and Negative Reference Voltages shows the CI3433 used to provide a 3.3V supply reference voltage. Take care to match the temperature coefficients of R1 and R2.

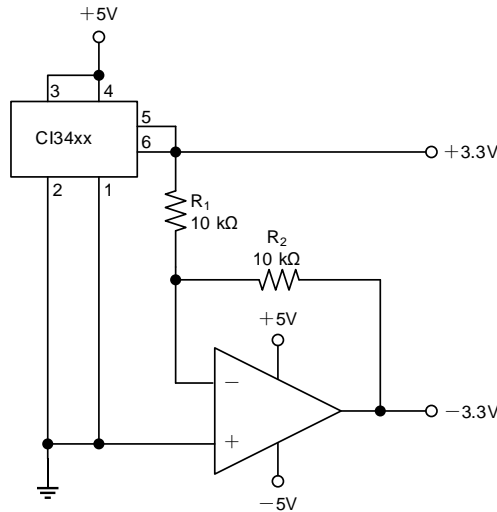


Figure 20: CI3433 Create Positive and Negative Reference Voltages

## 9 Power Supply Recommendations

The CI3433 family of references feature an extremely low-dropout voltage. These references can be operated with a supply of only 250 mV above the output voltage. Sensilicon recommends a supply bypass capacitor ranging between 0.1  $\mu$ F to 10  $\mu$ F.

## 10 Layout

### 10.1 Layout Guidelines

Figure 21 illustrates an example of a PCB layout for a data acquisition system using the CI3433. Some key considerations are:

- Connect low-ESR, 0.1- $\mu$ F ceramic bypass capacitors at IN, OUT\_F, VOUT of the CI3433.
- Decouple other active devices in the system per the device specifications.
- Using a solid ground plane helps distribute heat and reduce electromagnetic interference (EMI) noise pickup.
- Place the external components as close to the device as possible. This configuration prevents parasitic errors (such as the Seebeck effect) from occurring.
- Do not run sensitive analog traces in parallel with digital traces. Avoid crossing digital and analog traces if possible, and only make perpendicular crossings when absolutely necessary.

## 10.2 Layout Example

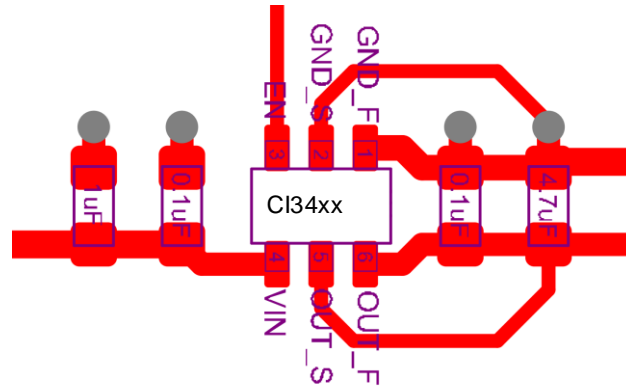
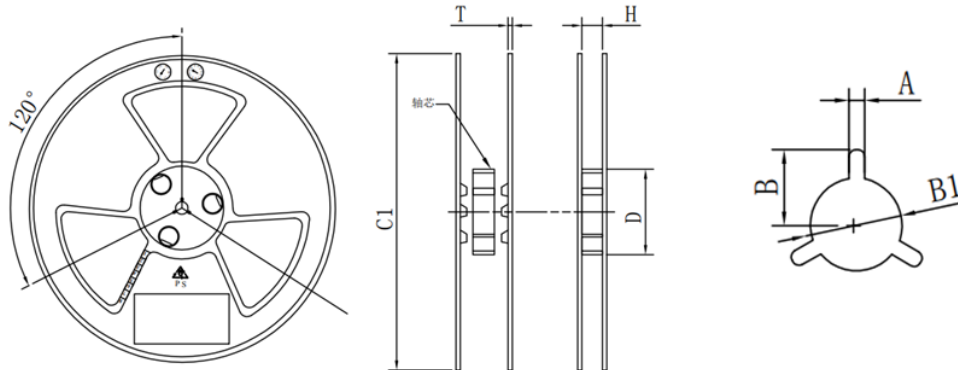
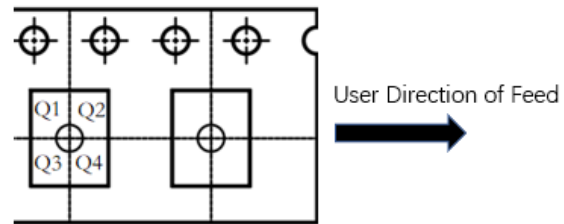


Figure 21: CI3433 PCB Layout Example

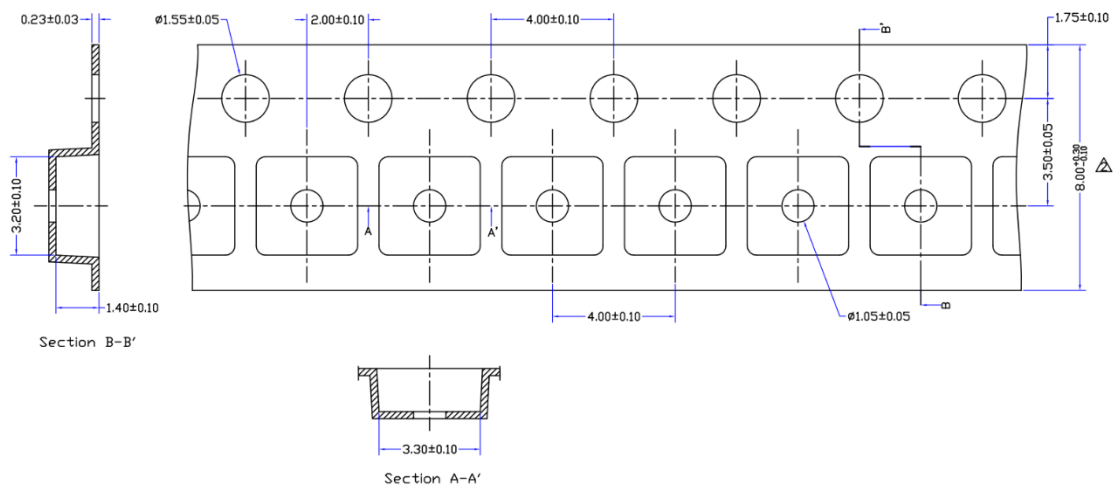
## 11 Tape and Reel Information



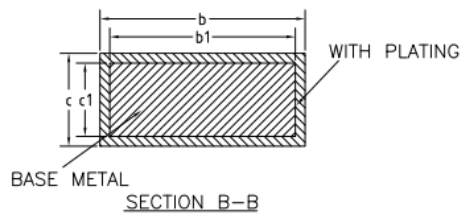
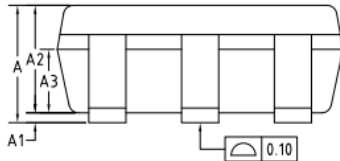
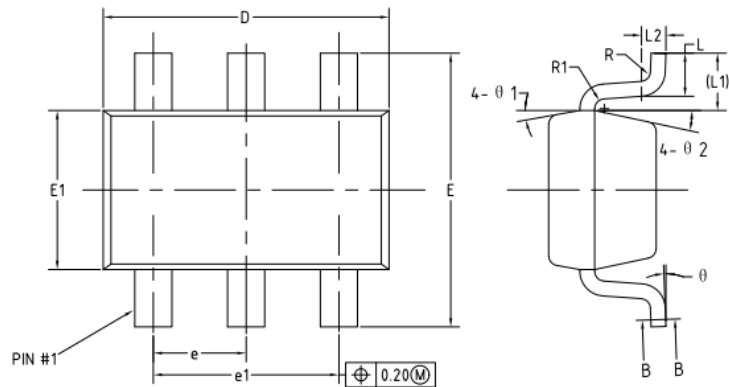
C1	178±1
H	8.4+1/-0
A	2.2±0.5
B	Ø13.5±0.2
T	1.2±0.2
D	Ø60±0.5
SPQ	300
Part Number	CI34xx
Pin1 Quadrant	Q3



Note: Q1~Q4 is Pocket Quadrants



## 12 Package Information



COMMON DIMENSIONS  
(UNITS OF MEASURE=MILLIMETER)

SYMBOL	MIN	NOM	MAX
A	—	—	1.25
A1	0	—	0.15
A2	1.00	1.10	1.20
A3	0.60	0.65	0.70
b	0.34	—	0.45
b1	0.34	0.38	0.41
c	0.12	—	0.20
c1	0.12	0.15	0.16
D	2.826	2.926	3.026
E	2.60	2.80	3.00
E1	1.526	1.626	1.700
e	0.90	0.95	1.00
e1	1.80	1.90	2.00
L	0.30	0.40	0.60
L1		0.59REF	
L2		0.25BSC	
R	0.05	—	0.20
R1	0.05	—	0.20
θ	0°	—	8°
θ 1	8°	10°	12°
θ 2	10°	12°	14°